

STC5NF30V

N-channel 30V - 0.027Ω - 5A - TSSOP8 2.7V-drive STripFET™ II Power MOSFET

General features

Туре	V _{DSS}	V _{DSS} R _{DS(on)}	
STC5NF30V	30V	< 0.031 Ω(@ 4.5 V) < 0.035 Ω(@ 2.7 V)	5A

- Ultra low threshold gate drive (2.7V)
- Standard outline for easy automated surface mount assembly

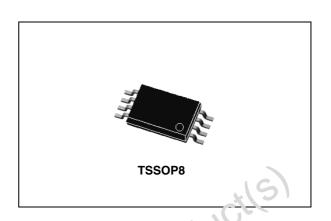
Description

This Power MOSFET is the latest development of STMicroelectronis unique "Single Feature SizeTM" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

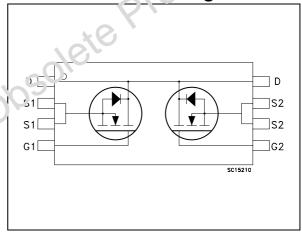
Applications

Switching application

Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging	
STC5NF30V	C5NF30V	TSSOP8		

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STC5NF30V **Electrical ratings**

Electrical ratings 1

Table 1. **Absolute maximum ratings**

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{DGR}	Drain-gate voltage ($R_{GS} = 20K\Omega$)	20	V
V_{GS}	Gate-source voltage	± 12	V
I _D	Drain current (continuous) at T _C = 25°C	5	Α
I _D	Drain current (continuous) at T _C =100°C	3	Α
I _{DM} ⁽¹⁾	Drain current (pulsed) 20		Α
P _{TOT}	Total dissipation at T _C = 25°C	1.5	W
T _{stg}	Storage temperature	-55 to 150	ç
TJ	Max. operating junction temperature	-55 to 150	°C
 Pulse width limited by safe operating area Table 2. Thermal data 			
Symbol	Parameter	Value	Unit

^{1.} Pulse width limited by safe operating area

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thJ-PBC}	Thermal resistance junction-PBC Max	100 (1)	°C/W
R _{thJ-PBC}	Thermal resistance junction-PBC Max	83.5 ⁽²⁾	°C/W

^{1.} When Mounted on FR-4 board with 1 inch² pad, 2 oz of Cu and t = 10 sec

Obsolete Product(S) 2. When Mounted on minimum recommended footprint

Electrical characteristics STC5NF30V

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	30			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	$V_{DS} = Max rating,$ $V_{DS} = Max rating @ 125°C$			1 10	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ±12V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6		,	٧
R _{DS(on)}	Static drain-source on resistance	V_{GS} = 4.5V, I_{D} = 2.5A V_{GS} =2.7V, I_{D} = 2.5A		0.027 0.031	0.031 0.035	Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} = 15 \text{ V}, I_{D} = 2.5 \text{A}$		9.5		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 15V, f = 1 \text{ MHz},$ $V_{GS} = 0$		460 200 50		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} =16V, I_{D} = 4.5A V_{GS} =4.5V Figure 15 on page 8		8.5 1.8 2.4	11.5	nC nC nC

^{1.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Table 5. Switching times

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10	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Obsole	$t_{ m d(on)} \ t_{ m r} \ t_{ m d(off)} \ t_{ m f}$	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} = 10V, I_{D} = 2.5A, R_{G} =4.7 Ω , V_{GS} =4.5V Figure 13 on page 8		7 33 27 10		ns ns ns ns
	$egin{array}{c} t_{ m d(off)} \ t_{ m f} \ t_{ m C} \end{array}$	Off-voltage rise time Fall time Cross-over time	Vclamp =16V, I_D = 5A R_G = 4.7 Ω , V_{GS} = 4.5V Figure 15 on page 8		26 11 21		ns ns ns

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Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				5	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				20	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 5A, V_{GS} = 0$			1.2	٧
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 5A, di/dt = 100A/ μ s, V_{DD} = 10V, T_{J} = 150°C Figure 15 on page 8		26 13 1		ns μC A

- 1. Pulse width limited by safe operating area
- 2. Pulsed: pulse duration=300µs, duty cycle 1.5%

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Electrical characteristics STC5NF30V

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

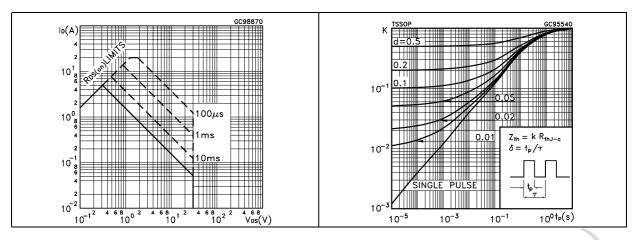


Figure 3. Output characteristics

Figure 4. Transfer characteristics

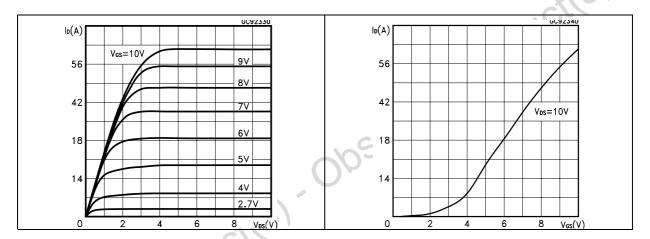
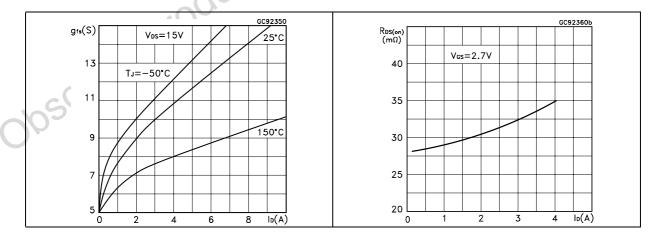


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



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Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

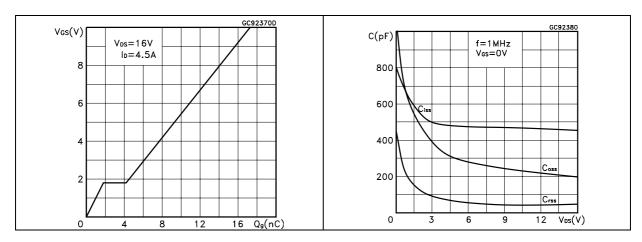


Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature

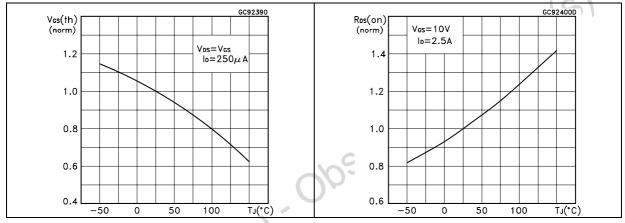
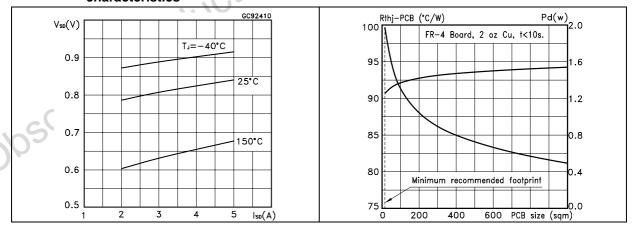


Figure 11. Source-drain diode forward characteristics

Figure 12. Thermal resistance and max power



Test circuit STC5NF30V

3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

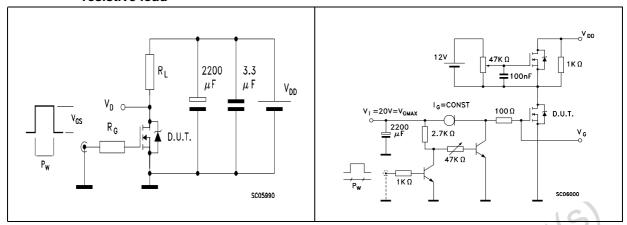


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

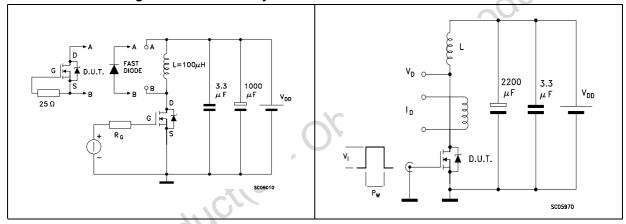
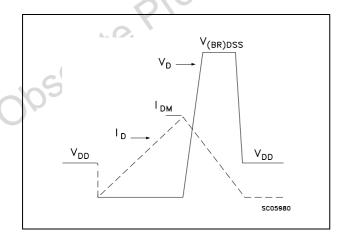


Figure 17. Unclamped inductive waveform



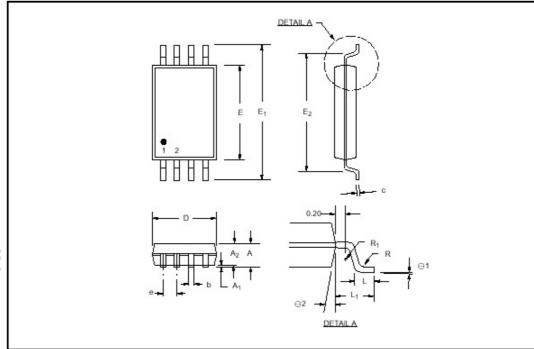
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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TSSOP8 MECHANICAL DATA

DIM.		mm.			inch	
DIW.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А	1.05		1.20	0.041		0.047
A1	0.05		0.15	0.002		0.006
A2	0.80		1.05	0.032		0.041
b	0.19		0.30	0.008		0.012
С		0.127			0.005	
D	2.90		3.10	0.114		0.122
E	4.30		4.50	0.170		0.177
E1	6.20		6.60	0.240		0.260
E2	5.14		5.24	0.202		0.206
е		0.65			0.025	
L	0.45		0.75	0.018		0.030
L1	0.90		1.10	0.0355		0.0433
R	0.09			0.004		
R1	0.09			0.004		
91	0°		8°	O°		8°
θ2		-	1	2°		



Obsole

STC5NF30V Revision history

5 Revision history

Table 7. Revision history

Date	Revision	Changes	
09-Sep-2004	1	First release	
08-Aug-2006	2	New template, SOA updated	

Obsolete Product(s). Obsolete Product(s)

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